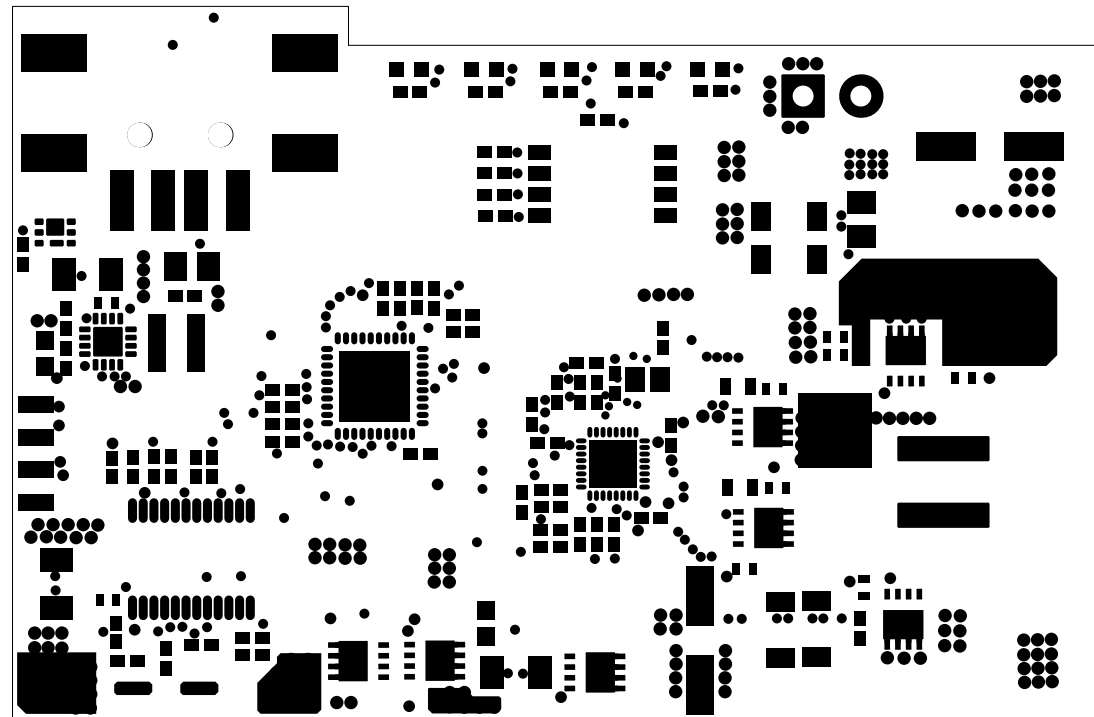
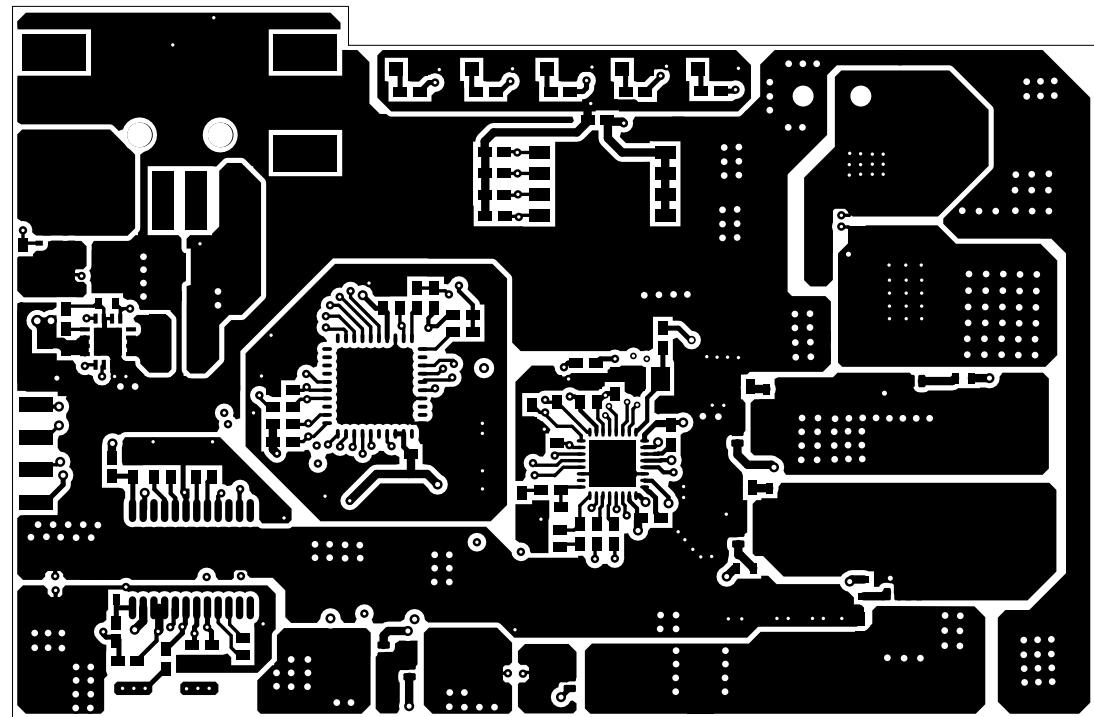


C13

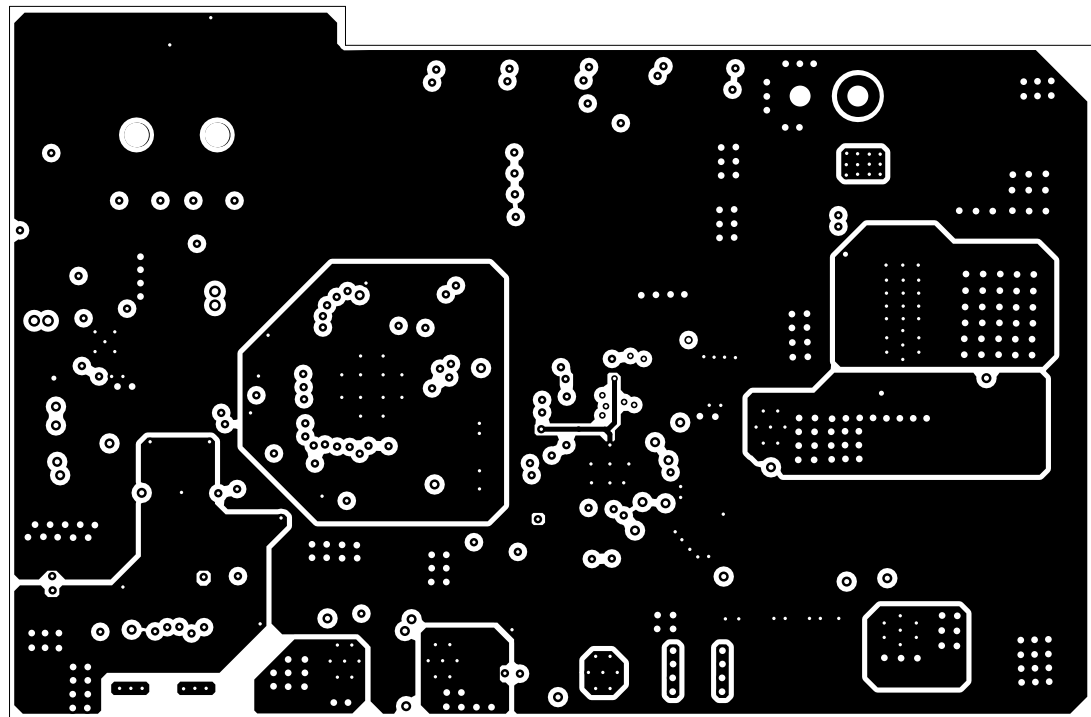
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40294	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: PMP40294		
PLOT NAME = Top Overlay	GENERATED : 10/30/2017 11:44:14 AM		TEXAS INSTRUMENTS



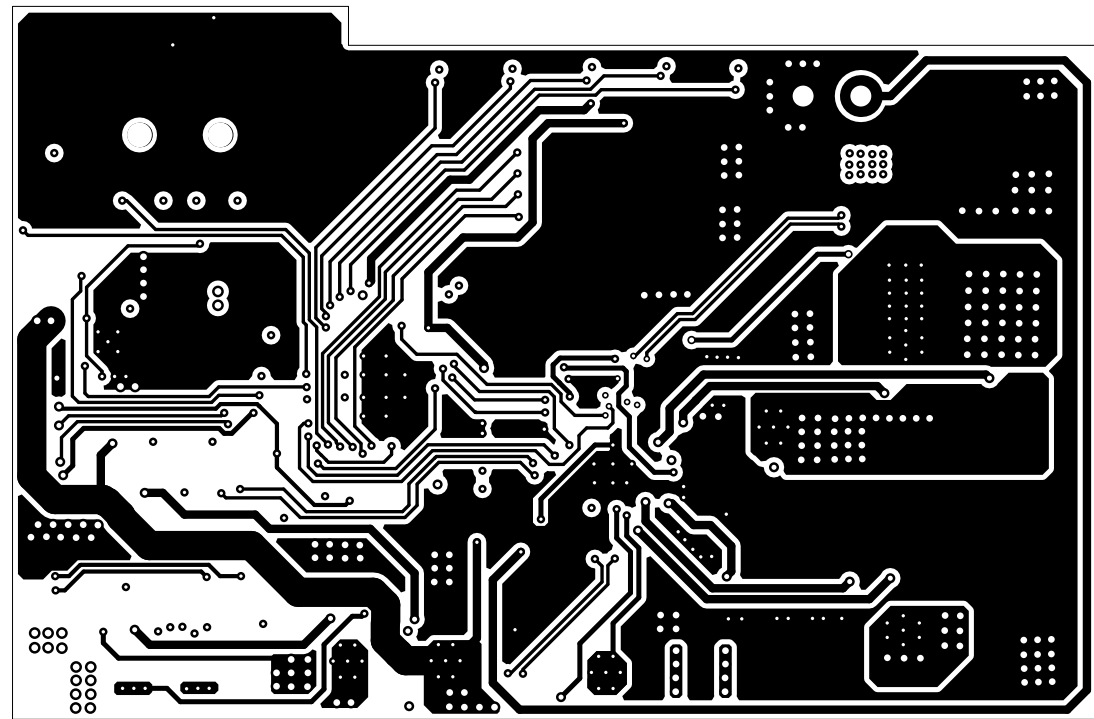
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40294	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: PMP40294		
PLOT NAME = Top Solder Mask	GENERATED : 10/30/2017 11:44:15 AM		TEXAS INSTRUMENTS



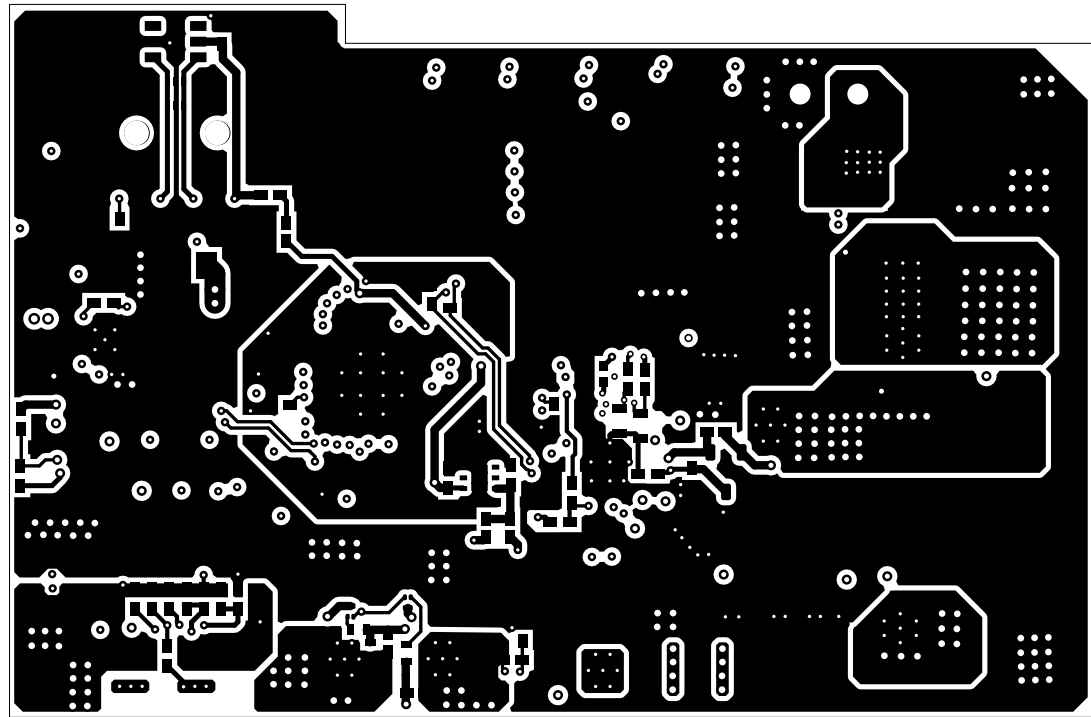
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40294	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: PMP40294		
PLOT NAME = Top Layer	GENERATED : 10/30/2017 11:44:16 AM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40294	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME =	TID #: PMP40294		
PLOT NAME = Signal Layer 1	GENERATED : 10/30/2017 11:44:17 AM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40294	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME =	TID #: PMP40294		
PLOT NAME = Signal Layer 2	GENERATED : 10/30/2017 11:44:18 AM		TEXAS INSTRUMENTS

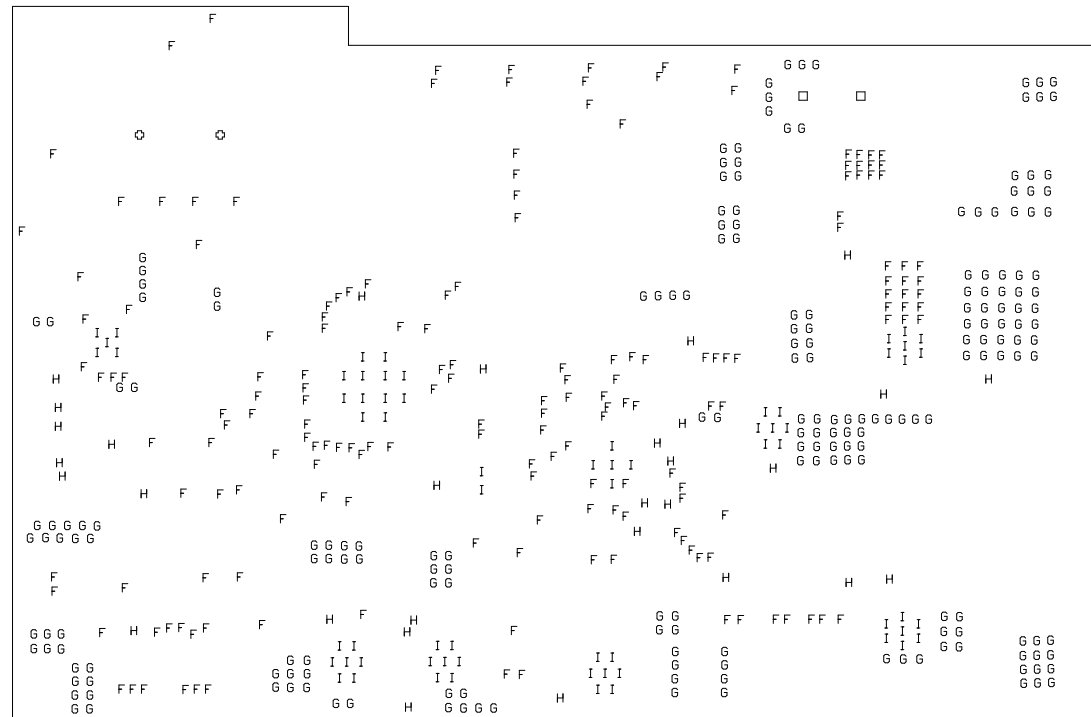


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40294	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: PMP40294		
PLOT NAME = Bottom Layer	GENERATED : 10/30/2017 11:44:19 AM		TEXAS INSTRUMENTS

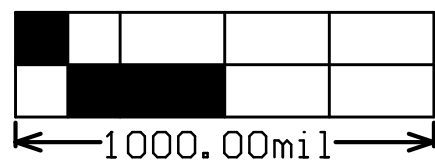
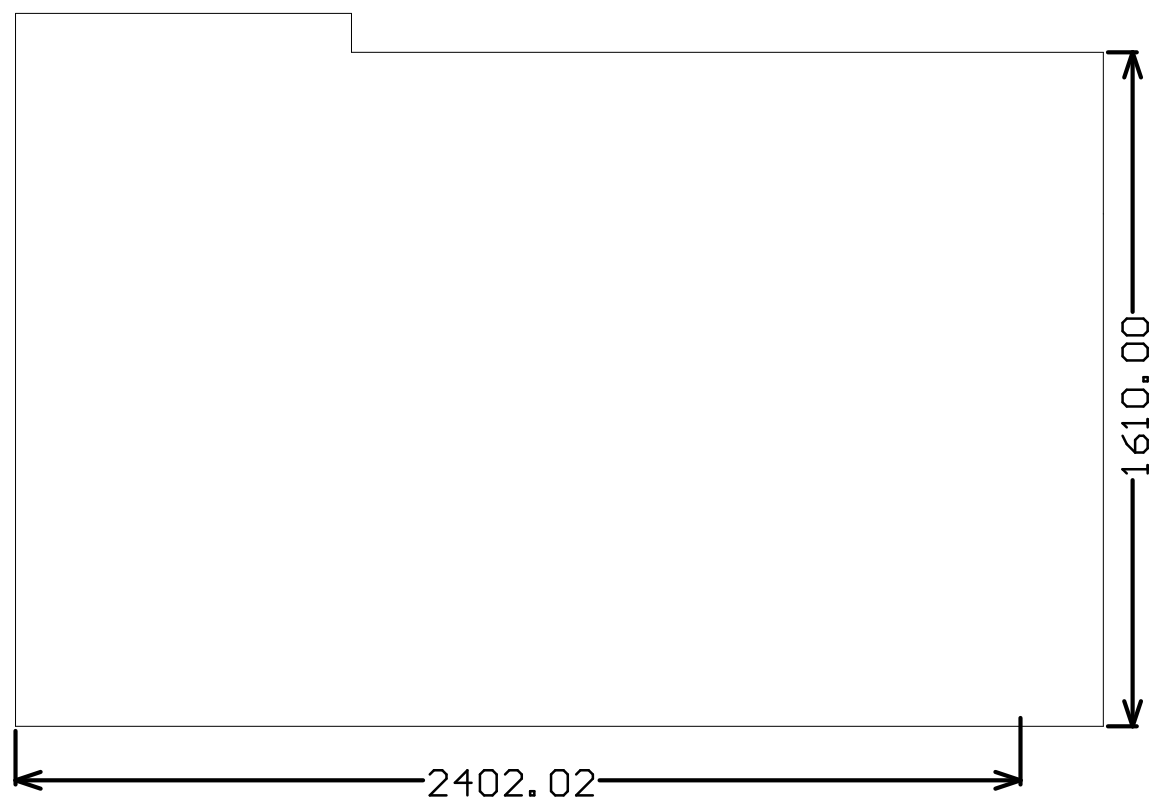


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40294	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: PMP40294		
PLOT NAME = Bottom Solder Mask	GENERATED : 10/30/2017 11:44:20 AM		TEXAS INSTRUMENTS

Symbol	Quantity	Finished Hole Size	Plated	Hole Type
⊙	2	59.06mil (1.500mm)	NPTH	Round
I	66	7.87mil (0.200mm)	PTH	Round
F	178	8.00mil (0.203mm)	PTH	Round
H	30	12.00mil (0.305mm)	PTH	Round
G	204	16.00mil (0.406mm)	PTH	Round
□	2	50.00mil (1.270mm)	PTH	Round
	482 Total			



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40294	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: PMP40294		
PLOT NAME = Drill Drawing	GENERATED : 10/30/2017 11:44:22 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40294	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: PMP40294		
PLOT NAME = Board Dimensions	GENERATED : 10/30/2017 11:44:24 AM		TEXAS INSTRUMENTS

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